



# SHA106

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## SHA106 CryptoAuthentication™ Summary Data Sheet

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### Introduction

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The SHA106 is a member of Microchip Technology Inc. CryptoAuthentication™ product family used in accessory or disposable applications. The device is a parasitically-powered Single-Wire Interface (SWI) version of the SHA104. The device provides 128-bits of symmetric security targeted for disposable and ecosystem control applications and is intended to be used as a companion device and is microcontroller/microprocessor agnostic. The device can be used in systems where either the host can assist in the authentication through the use of a challenge-response pair or, for more security, can be used with a host side security device to perform a CheckMAC operation. The SHA106 can be used in conjunction with the SHA105 or other Microchip CryptoAuthentication host side devices.

### Features

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- Cryptographic Authentication Device with Secure Hardware-Based Key Storage:
  - Protected storage for symmetric key
- Hardware Support for MAC Generation
- Internal High-Quality NIST SP 800-90A/B/C Random Number Generator (RNG)
- Extensive Security Measures Against Attacks
- Strong Physical Protection Mechanisms Against Invasive Attacks
- Field-Programmable EEPROM
  - Single symmetric secret key
  - 384-byte user memory
  - 40-year data retention at +55°C
- Monotonic Counter with Max Count Value of 10,000
  - Counter can be attached to key for limited use
- Unique 72-Bit Serial Number
- Interface: 125 kbps Pulse Width Modulated (PWM) SWI
- Parasitically Powered through SIO Signal. Input Range 2.5 to 5.5 volts
- 130 nA Nominal Sleep Current
- Human Body Model (HBM) ESD: >7 kV
- Packaging Options: 2-Lead VSFN (2.0 mm x 2.35 mm) Contact Package

### Use Cases

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- Disposables and accessory authentication
- Ecosystem control
- Anti-cloning

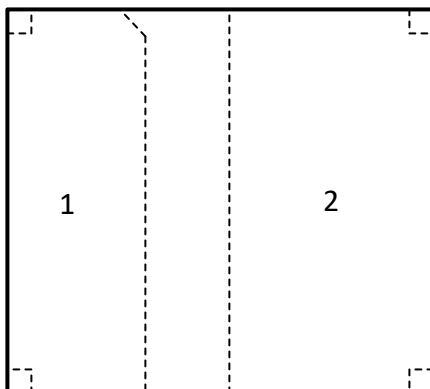
## Pin Configuration and Pinouts

Table 1. Pin Configuration

2-PAD VSFN		
Pin #	Function	SWI-PWM
1	Ground	GND
2	Serial I/O	SI/O

Figure 1. Pinout

2-Lead VSFN  
(Top View)



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## 1. Overview

### 1.1 Use Cases

SHA106 is a member of the Microchip CryptoAuthentication family of high-security cryptographic devices that combine world class hardware-based key storage with hardware cryptographic accelerators to implement authentication.

SHA106 has a command set that allows for its usage in multiple symmetric key applications. The primary uses include the following:

- **Accessory/Disposable Authentication**  
Allows for authentication of accessory and or disposable system components. For disposable components, the use may be restricted through the use of a monotonic counter.
- **Ecosystem Control and Anti-Counterfeiting**  
Validates that a system or component is authentic and came from the OEM shown on the nameplate.

In typical applications, the SHA106 will be used on the accessory/disposable side of an application and the SHA105 will be used on the host side of that application.

#### 1.1.1 2-Lead VSFN Contact Package

The 2-Lead VSFN contact package is a unique package that is especially suited for disposable and accessory applications where a cartridge or accessory is replaced on a regular basis. Typical integrated circuit packages require the package to be soldered down to a PCB. Most often this board has multiple ICs and/or passive devices.

For disposable applications where the only reason to add electronics is to authenticate the disposable, the requirement is often reduced to a single cryptographic IC plus a decoupling capacitor. The SHA106 contains both the IC and the decoupling capacitor so all electronics needed by the disposable are entirely contained in the packaged device. An alternative method to connect to the package, then, can eliminate the need for a PCB in the system.

Contact packages provide a unique solution where, instead of soldering the pads of the device down to a PCB board, the package is, instead, attached to the accessory by gluing the top side of the package to the accessory. The pads of the package are left exposed for future connection to the host system. Typically, some sort of a 2-pin contactor or pogo pin connections are used to connect the accessory device to the host system. This approach allows for a simple and reliable connection between the disposable and the host device, while minimizing the cost to add authentication to the accessory.

### 1.2 Device Features

SHA106 includes an EEPROM array that can be used for storage of one secret key, miscellaneous read/write data, consumption logging and security configurations. Write access to the various data zone slots and configuration subzones of memory can be restricted.

The SHA106 supports a Microchip proprietary PWM SWI operating in parasitic power mode. This reduces the total pin count of the interface to just two pins: a Ground Signal and the Serial I/O Signal. Power is provided to the device through the Serial I/O signal and a capacitor internal to the package.

Each SHA106 unit ships with a unique 72-bit serial number. Also, SHA106 features a wide array of defense mechanisms specifically designed to prevent physical attacks on the device itself or logical attacks on the data transmitted between the device and the system. Hardware restrictions on the ways in which a key is used or generated provide further defense against certain styles of attack.

An enhanced mode of self-test can be enabled by setting the SelfTest bit in the Configuration Zone. In this mode, the tests are required to run prior to the execution of the commands that require cryptographic algorithms.

The SHA106 device has a monotonic counter that can be used by the host system for a purpose of its choosing. The maximum value of the counter is limited to a maximum of 10,000 uses. A lower value can be programmed into the device during provisioning if so desired. If so desired, the counter can be attached to the symmetric key in Slot 3 to

limit the use of this key. The monotonic counter will be automatically updated when the MAC command is run if the key in Slot 3 is configured for limited use.

## 2. **Static RAM (SRAM) Memory**

The device also includes an SRAM array that is used to store the input command or output result, intermediate computation values, etc. The contents of the SRAM can never be read directly, only used internally by the secure element. The entire contents of this memory are invalidated whenever the device goes into Sleep mode, tamper reset or the power is removed. SRAM Address and Data are scrambled.

**TempKey** Internal memory location that stores an intermediate value used in calculations. The value cannot be read but can be used by subsequent commands.

### 3. Security Information

#### 3.1 Cryptographic Standards

SHA106 follows various industry standards for the computation of cryptographic results. These reference documents are described in the following sections. See the Microchip website for further documentation on NIST CAVP certification of these cryptographic functions.

##### 3.1.1 SHA-256

The SHA106 computes the SHA-256 digest based on the algorithm documented here:

<http://nvlpubs.nist.gov/nistpubs/FIPS/NIST.FIPS.180-4.pdf>

#### 3.2 Key Uses and Restrictions

##### 3.2.1 Symmetric Keys

The parent symmetric secret key is stored in Slot 3 of the data zone and is 32 bytes (256 bits) in length. This key is based on SHA-256 cryptography and provides 128 bits of key strength. For the host (SHA105) device, the parent symmetric key must always be programmed into the device. For the client device, either the parent or a diversified key may be programmed into Slot 3.

##### 3.2.2 Monotonic Counter

SHA106 supports one nonvolatile monotonic counter that can count to a value of 10,000.

The counters can be used in one of two methods :

- **Cryptographic Counters:**

In this mode, the value of the counter can be read or incremented. It is the responsibility of the host to determine how this counter is used.

- **Limited Key Use:**

The monotonic counter can be attached to the Symmetric Key stored in Slot 3 to restrict the number of times this key can be used.

##### 3.2.3 Transport Keys

The SHA106 includes an internal hardware set of keys that is used for secure personalization (i.e., transport keys). The values of the hardware keys are kept secret and are made available only to qualified customers upon request to Microchip. Microchip also offers secure personalization services through the Trust Platform provisioning services. Contact your local Microchip Sales Office for more information on such services.

### 3.3 Security Features

#### 3.3.1 Physical Security

The SHA106 incorporates a number of physical security features designed to protect the EEPROM contents from unauthorized exposure.

#### 3.3.2 Random Number Generator (RNG)

The SHA106 device includes a high-quality cryptographic RNG implemented according to the NIST standards SP800-90A/B/C.



## 4. Electrical Characteristics

### 4.1 Absolute Maximum Ratings

Operating Temperature	-40°C to +105°C
Storage Temperature	-65°C to +150°C
Maximum Operating Voltage	6.0V
DC Output Low Current	20 mA
Voltage on any Pin -0.5V to (V <sub>CC</sub> + 0.5V)	-0.5V to (V <sub>CC</sub> + 0.5V)
<b>ESD Ratings:</b>	
Human Body Model (HBM) ESD	>7 kV
Charge Device Model (CDM) ESD	>2 kV

**Note:** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### 4.2 Reliability

The SHA106 is fabricated with Microchip’s high-reliability CMOS EEPROM manufacturing technology.

**Table 4-1. EEPROM Reliability**

Parameter	Min	Typ.	Max.	Units
Data Retention at +55°C	>40	—	—	Years
Read Endurance	Unlimited			Read Cycles

**Note:**

- The number of times that an EEPROM cell would be written is expected to be minimal for most use cases. Maximum EEPROM write cycles are expected to occur when the monotonic counter is used, which can be incremented up to 10,000 times. Similar devices in this technology have a write endurance of >100k.

### 4.3 DC Parameters

#### 4.3.1 DC Parameters: Single-Wire Interface – Parasitic Power Mode

**Table 4-2. DC Parameters on Parasitic Single-Wire Interface**

Unless otherwise indicated, values are applicable over the specified operating range from T<sub>A</sub> = -40°C to +105°C, CMOS<sub>Sen</sub>=1

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Ambient Operating Temperature	T <sub>A</sub>	-40	—	+105	°C	—
Max. I/O Voltage <sup>(1)</sup>	V <sub>PUP</sub>	2.5	—	5.5	V	R <sub>PUP</sub> must be chosen such that V <sub>PUP</sub> – R <sub>PUP</sub> *I <sub>CC</sub> ≥ 2.0V

.....continued						
Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Output Low Voltage	$V_{OL}$	—	—	0.4	V	When the device is in Active mode, $V_{PUP} = 2.5V$ to $3.6V$ for output-low current = $8.0$ mA
Input Low Leakage <sup>(3)</sup>	$I_{IL}$	-200	—	200	nA	$V_{IN} = GND$
Input Low Threshold	$V_{IL1}$	-0.5	—	$0.3 \cdot V_{SIO}$	V	CMOSen = 1
Input High Threshold	$V_{IH1}$	$0.7 \cdot V_{SIO}$	—	$V_{SIO} + 0.5$	V	CMOSen = 1
Sleep Current <sup>(2)</sup>	$I_{SLEEP}$	—	130	$325^{(4)}$	nA	When the device is in Sleep mode, $V_{SIO} \leq 3.6V$ , I/O at GND $T_A \leq +55^\circ C$
		—	130	500	nA	When the device is in Sleep mode, $V_{SIO} \leq 3.6V$ , I/O at GND Full Temperature Range
		—	130	1000	nA	When the device is in Sleep mode. Over full $V_{SIO}$ and temperature range.
Current Consumption in I/O Mode	$I_{I/O}$	—	80	250	$\mu A$	Waiting for I/O
Bus Capacitance	$C_{BUS}$	—	—	500	pF	—
Theta JA	$\Theta_{JA}$	—	TBD	—	$^\circ C/W$	2-PAD VSFN

**Notes:**

1. Single-Wire voltage ( $V_{PUP}$ ) must never be greater than the maximum  $V_{PUP}$  operating voltage.
2. For the lowest system current, the SI/O signal must be driven to  $V_{PUP}$  by the host or allowed to be pulled up by the pull-up resistors.
3. Input High leakage can not be measured because the device and decoupling capacitor is charged via the SI/O signal.
4. This condition is characterized but not production tested.

## 5. SHA106 Trust Platform Variants and Provisioning Services

Microchip offers secure provisioning services for the SHA106 through the [Trust Platform](#). It leverages the [Trust Platform Design Suite](#) (TPDS) set of tools, and currently offers 3 provisioning flows:

- Trust&GO: Pre-configured and pre-provisioned Secure Elements for fix-function Use Cases
- TrustFLEX: Pre-configured & provisioned Secure Element with customer-unique credentials
- TrustCUSTOM: Fully customizable Secure Element including configuration and provisioning with customer-unique credentials

The [Trust&GO](#) flow provides pre-configured and pre-provisioned secure elements. These products are defined to meet common use case applications for customers that do not require unique credentials. These devices are provided as-is and can be ordered directly from Microchip as easily as any standard product.

The [TrustFLEX](#) flow leverages the TrustFLEX configurator to input unique customer credentials into a pre-defined configuration and generate a Secure Exchange Package. This package is, then, deployed via the Microchip Secure Provisioning System to enable device ordering. Then, only the customer designated in the Secure Exchange Package can order these devices.

The [TrustCUSTOM](#) flow leverages the TrustCUSTOM configurator and provides the ability to fully configure the SHA106 device to meet the security requirements for a given application. At the end of the process, a Secure Exchange Package is generated that is deployed to the Microchip Secure Provisioning System. Then, only the customer designated in the Secure Exchange Package can order these devices.



**Important:** Microchip's test sites, that provide secure provisioning services, are equipped with Hardware Security Modules (HSMs) to ensure the security of customer data throughout the provisioning process.

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### SHA106 Trust Platform Products

The SHA106 is supported by Microchip's Trust Platform provisioning flow. The TPDS tools can be used to support configuring the devices for the purpose of prototyping, design evaluation and secure provisioning services (i.e., onboarding). The device is only available in the 2-Lead VSFN package and only the SWI is possible. Through use of the [EV98D91A](#) 2-Lead VSFN Socket Kit, combined with the [DM320118](#) Trust Platform development board, units can be configured and programmed. For Trust Products with similar capabilities to the SHA106, review the SHA104 and SHA104-TFLXAUTH products on the Microchip website.

## **6. Package Marking Information**

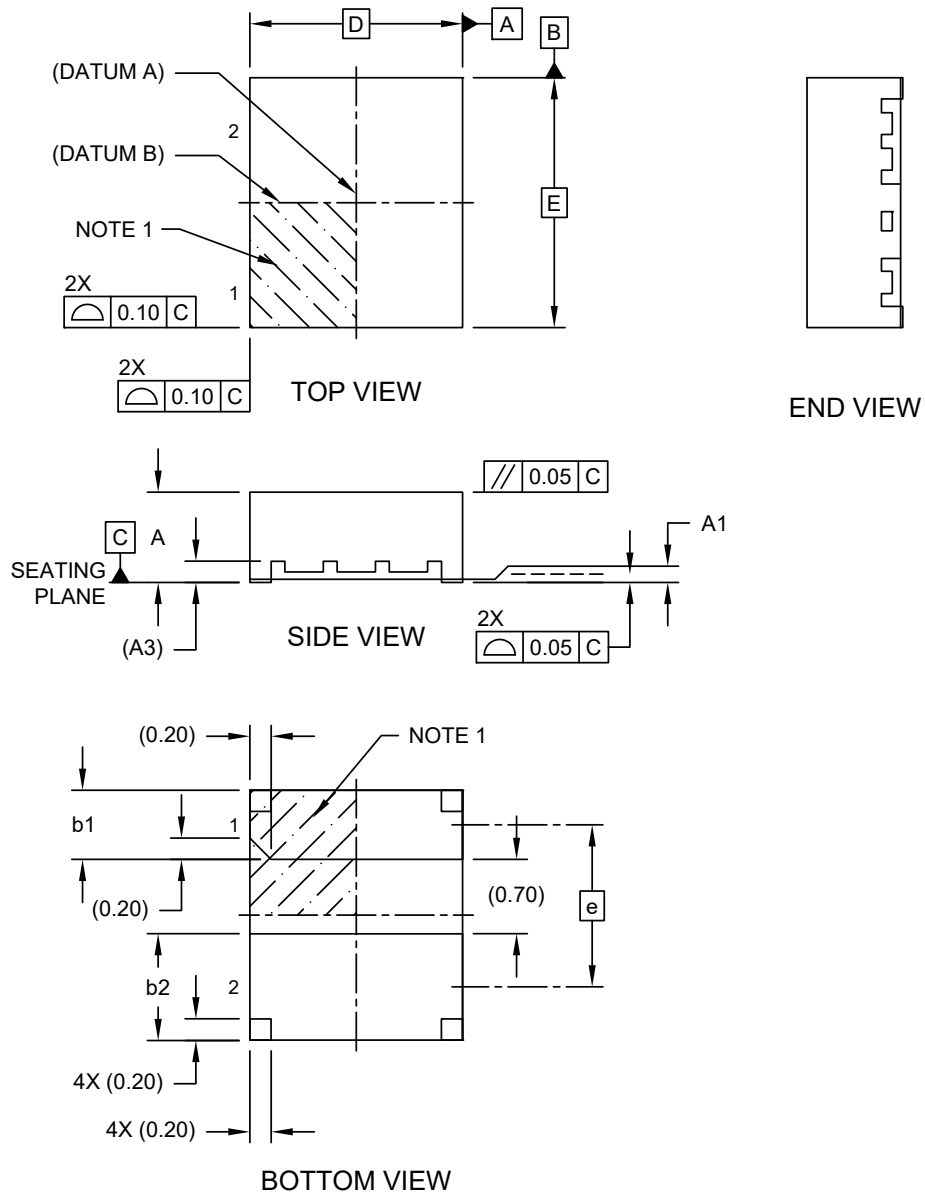
As part of Microchip's overall security features, the part marking for all crypto devices is intentionally vague. The marking on the top of the package does not provide any information as to the actual device type or the manufacturer of the device. The alphanumeric code on the package provides manufacturing information and will vary with assembly lot. It is recommended that the packaging mark not be used as part of any incoming inspection procedure.

## 7. Package Drawings

### 7.1 2-Lead VSFN Contact Package

#### 2-Lead Very Thin Single Flatpack No Lead Package (2EW) - 2.0x2.35x0.9 mm Body [VSFN]

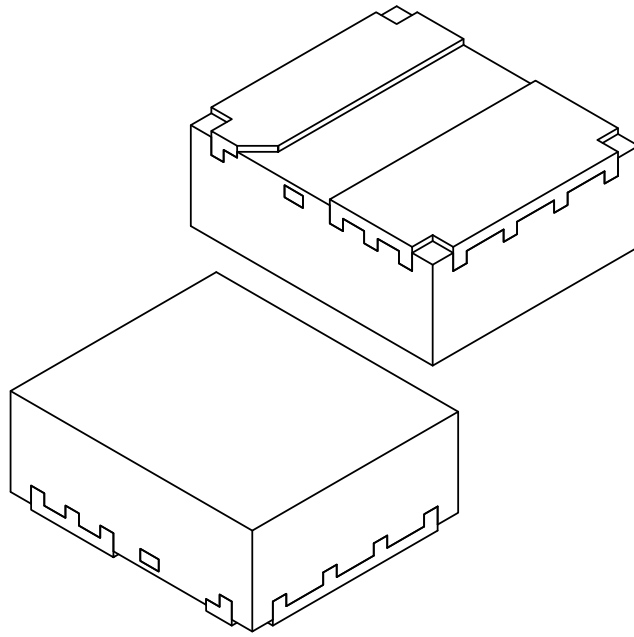
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-540 Rev A Sheet 1 of 2

### 2-Lead Very Thin Single Flatpack No Lead Package (2EW) - 2.0x2.35x0.9 mm Body [VSFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		MILLIMETERS		
Units		MIN	NOM	MAX
Dimension	Limits			
Number of Terminals	N	2		
Pitch	e	1.525 BSC		
Overall Height	A	0.80	0.85	0.90
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.203 REF		
Overall Length	D	2.00 BSC		
Overall Width	E	2.35 BSC		
Terminal Width	b1	0.60	0.65	0.70
Terminal Width	b2	0.95	1.00	1.05

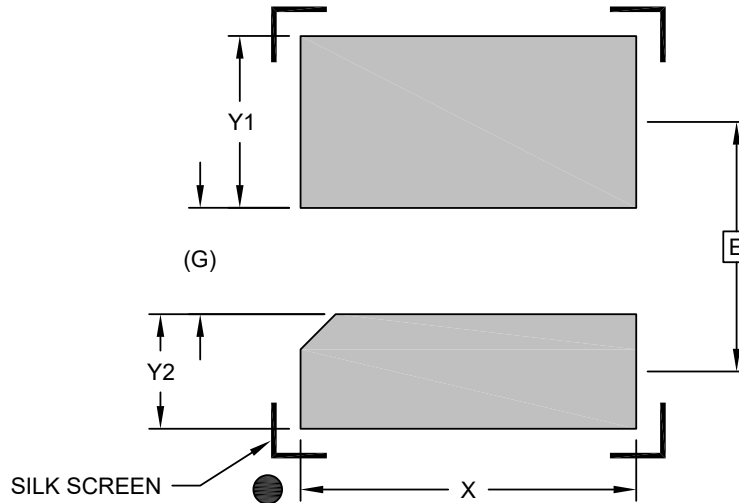
**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M  
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
 REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-540 Rev A Sheet 2 of 2

**2-Lead Very Thin Single Flatpack No Lead Package (2EW) - 2.0x2.35x0.9 mm Body [VSFN]**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



**RECOMMENDED LAND PATTERN**

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	1.525 BSC		
Contact Pad Length (X2)	X			2.10
Contact Pad Width	Y1			1.05
Contact Pad Width	Y2			0.70
Contact Pad to Center Pad (Xnn)	G	0.587 REF		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2540 Rev A

## **8. Revision History**

### **Revision A (March 2023)**

- Initial data sheet release



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## Microchip Information

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- Embedded Solutions Engineer (ESE)
- Technical Support

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## Product Identification System

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	-XX	X	XX	-X
Device	Package	Temp Range	I/O Type	Tape and Reel

Device:	SHA106: Cryptographic Co-processor with Secure Hardware-based Key Storage	
Package Options	MC	2-Pad VSFN 2.0 x 2.35mm Contact package
Temperature Option	V	Extended Industrial Temperature Range. -40°C to 105°C
I/O Type	CZ	Single Wire Interface
Tape and Reel Options	B	Bulk units in Canister

Examples:

- SHA106-MCVCZ-B: 2-Pad VSFN Contact package, Single-Wire, Bulk, 10,000 devices per canister.

Notes:

1. Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package.
2. Small form-factor packaging options may be available. Please check [www.microchip.com/packaging](http://www.microchip.com/packaging) for small-form factor package availability, or contact your local Sales Office.

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ISBN: 978-1-6683-2048-8

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